

N-Channel 60V, 1.4m Ω max., TOLT MOSFET

Product Summary					
V _{DS} (V)	$R_{DS(on),max}$ (m Ω)	I _D (A)			
60	1.4 @ V _{GS} = 10V	420 (1)			

Features

- ❖ Low RDS(on)
- Trench power MOSFET
- Low Gate Charge

Application

- Stored energy
- ❖ Electric motorcycle

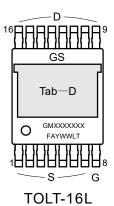
General Information

Shipping

- One shipping options is offered as standard
- Un-sawn wafer

Handling

- Product must be handled only at ESD safe workstations. Standard ESD precautions and safe work environments are as defined in MIL-HDBK-263.
- Product must be handled only in a class 10,000 or better-designated clean room environmen



NOTE: LOGO - GS

TOLT

GM - Part number code

F - Fab location code

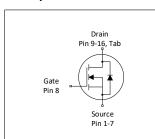
A - Assembly location code

Y - Year code

WW - Week code

L&T - Assembly lot code

Equivalent circuit



Absolute Maximum Rating (Ta=25°C)

Parameter			Limit	Unit
Drain-source voltage			60	V
Gate-source voltage			± 20	V
Continuous dusin surrout	T _C =25°C ⁽¹⁾	l _D	420	
Continuous drain current	T _C =100°C ⁽¹⁾		294	A
Pulsed drain current ⁽²⁾		I _{D,pulse}	1678	
Avalanche energy, single pulse ⁽³⁾		E _{AS}	1750	mJ
Power dissipation	T _C =25°C	P _D	431	W
Operating junction and storage temperature range			-55 to 175	°C

Thermal Characteristic (Ta=25°C)

Parameter	Symbol	Max.	Unit		
Thermal resistance, junction-to-case	Steady state	Rejc	0.29	90/M/	
Thermal resistance, junction-to-ambient (4)	Steady state	R _{0JA}	40	°C/W	



Electrical characteristics (Ta=25°C ± 3°C)						
Parameter	Symbol	Test conditions	Min.	Тур.	Max.	Unit
Static parameter						
Drain to source breakdown voltage	V _{(BR)DSS}	R)DSS V _{GS} = 0 V, I _D = 1 mA				V
Gate-source threshold voltage	$V_{GS(th)}$	V _{DS} = V _{GS} , I _D = 250 μA	2.0	3.0	4.0	V
Gate-body leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 60 V, V _{GS} = 0 V			1	μΑ
Drain-source on-resistance	R _{DS(on)}	V _{GS} = 10 V, I _D = 20 A		1.1	1.3	mΩ
Forward transconductance ⁽⁵⁾	g _{fs}	V _{DS} = 5 V, I _D = 20 A		56		S
Gate resistance	Rg	f = 1 MHz, open drain		2.4		Ω
Dynamic ⁽⁵⁾						
Total gate charge	Q_g			108		
Gate-source charge	Q_{gs}	V _{DS} = 30 V, I _D = 20 A, V _{GS} = 10 V		26		nC
Gate-drain charge	Q_{gd}			24		
Turn-on delay time	t _{d(on)}			28		
Rise time	t _r	$V_{DS} = 30 \text{ V}, I_{D} = 20 \text{ A}, V_{GS} = 10 \text{ V},$		45		no
Turn-off delay time	t _{d(off)}	R _{GEN} = 3.0 Ω		73		ns
Fall time	t _f			95		
Input capacitance	C _{iss}			7204		
Output capacitance	C _{oss}	V _{DS} = 30 V, V _{GS} = 0 V, f = 1 MHz		3129		pF
Reverse transfer capacitance	C_{rss}			202		
Reverse Diode Characteristics(5)						
Diode forward voltage	V _{SD}	$V_{GS} = 0 \text{ V}, I_F = 2.0 \text{ A}$		0.7	1.2	V
Reverse recovery time	t _{rr}	I _F = 20 A, di/dt = 100 A/μs		73		ns
Reverse recovery charge	Qrr	11 20 A, αl/αι - 100 A/μ5		95		nC

Notes

- (1) Package limited.

- (2) Pulse width limited by maximum junction temperature.
 (3) V_{DS} = 60 V, V_{GS} = 10 V, L = 1.0 mH.
 (4) R_{θJA} is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5x1.5 in. board of FR-4 material.
 (5) Guaranteed by design, not subject to production testing.



Electrical characteristics diagrams

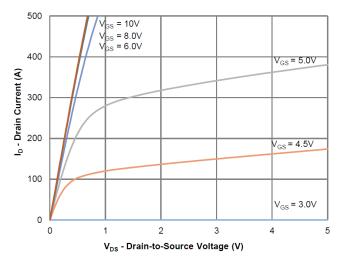


Figure 1: Output Characteristics

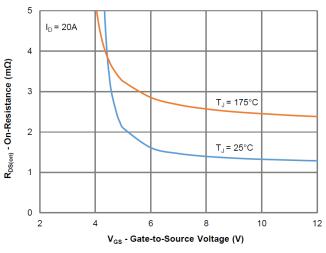


Figure 3: On-Resistance vs. Gate-Source Voltage

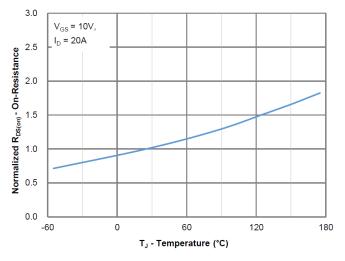


Figure 5: On-Resistance vs. Junction Temperature

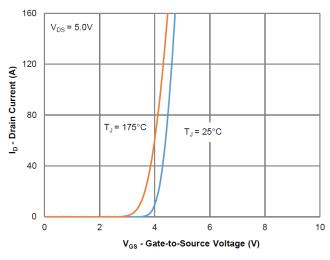


Figure 2: Transfer Characteristics

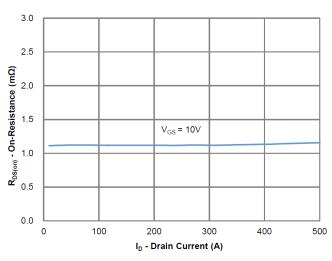


Figure 4: On-Resistance vs. Gate-Source Voltage

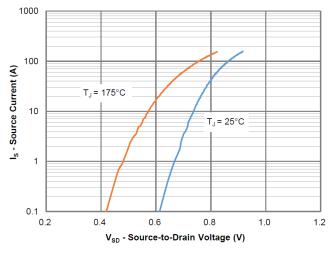


Figure 6: Source-Drain Diode Forward Voltage



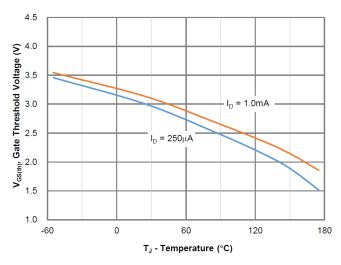


Figure 7: Gate Threshold Variation vs. Junction Temperature

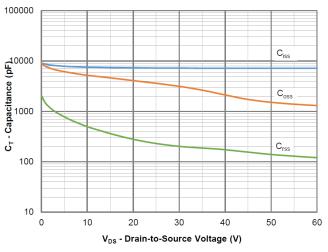


Figure 9: Capacitance Characteristics

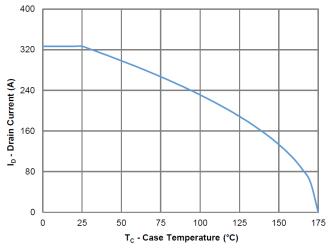


Figure 11: Current Derating

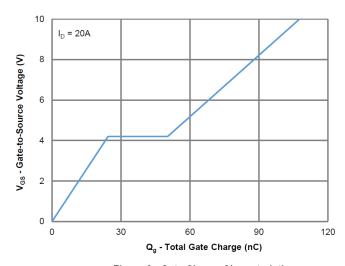


Figure 8: Gate Charge Characteristics

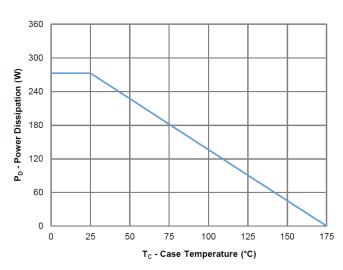


Figure 10: Power Derating

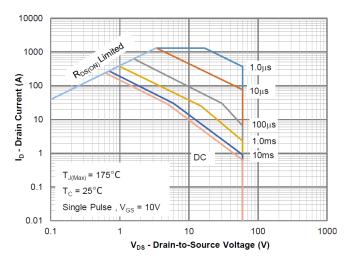


Figure 12: Safe Operating Area



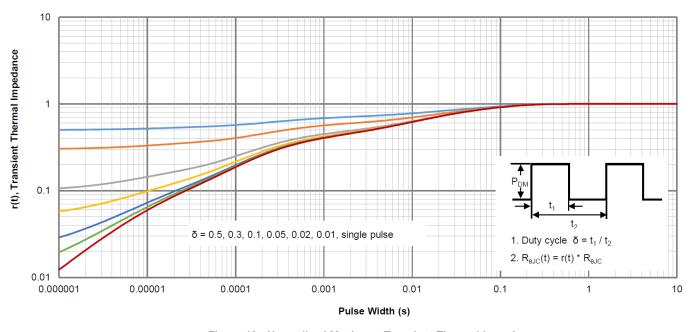
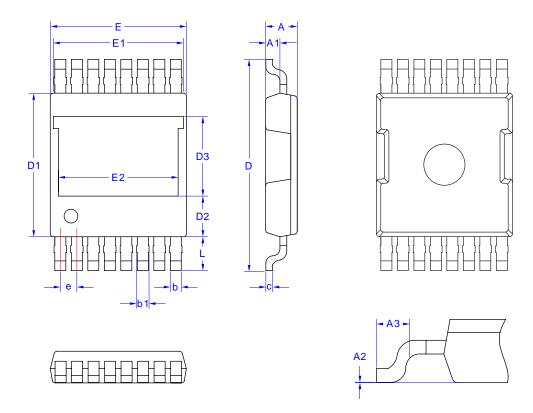


Figure 13: Normalized Maximum Transient Thermal Impedance



Package outline dimensions: TOLT



Symbol	Dimensions in Millimeters				
Symbol	MIN	NOM	MAX		
Α	2.20	2.30	2.40		
A1	0.99	1.04	1.09		
A2	0.00	0.08	0.16		
A3	1.50 REF				
b	0.70	0.75	0.80		
b1	0.65	0.70	0.75		
С	0.45	0.50	0.55		
D	14.50	15.00	15.50		

Symbol	Dimensions in Millimeters			
Syllibol	MIN	NOM	MAX	
D1	9.60	10.10	10.60	
D2	2.30	2.80	3.30	
D3	5.77 REF			
Е	9.40	9.90	10.40	
E1	9.46 REF			
E2	8.70 REF			
е	1.15	1.20	1.25	
L	2.40	2.45	2.50	



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